

## Features

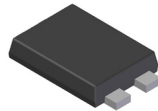
- 43% Smaller than SOT223; 60% Smaller than TO252
- Maximum Height: 1.1mm
- Rated up to 3.2W
- $V_{CE0} = -140V$
- $I_C = -4A$ ;  $I_{CM} = -10A$
- Low Saturation Voltage
- **Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q101, PPAP capable, and manufactured in IATF16949 certified facilities), please contact us or your local Diodes representative.**
- <https://www.diodes.com/quality/product-definitions/>

## Applications

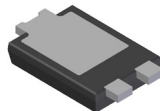
- SLIC DC-DC Converter

## Mechanical Data

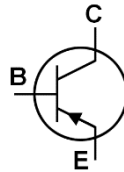
- Case: PowerDI<sup>®</sup>5
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish – Matte Tin annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 @3
- Weight: 0.093 grams (Approximate)



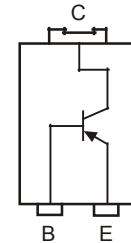
Top View



Bottom View



Device Schematic



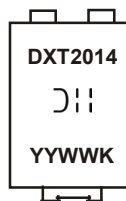
Pin-out diagram

## Ordering Information (Note 4)

Part Number	Marking	Reel Size (Inches)	Tape Width (mm)	Quantity per Reel
DXT2014P5-13	DXT2014	13	16	5000

- Notes:
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
  2. See <https://www.diodes.com/quality/lead-free/> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
  3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
  4. For packaging details, go to our website at <https://www.diodes.com/design/support/packaging/diodes-packaging/>.

## Marking Information



- DXT2014 = Product Type Marking Code
- = Manufacturers' Code Marking
- K = Factory Designator
- YYWW = Date Code Marking
- YY = Last Two Digits of Year (ex: 19 for 2019)
- WW = Week code (01 to 53)

**Maximum Ratings** (@T<sub>A</sub> = 25°C unless otherwise specified)

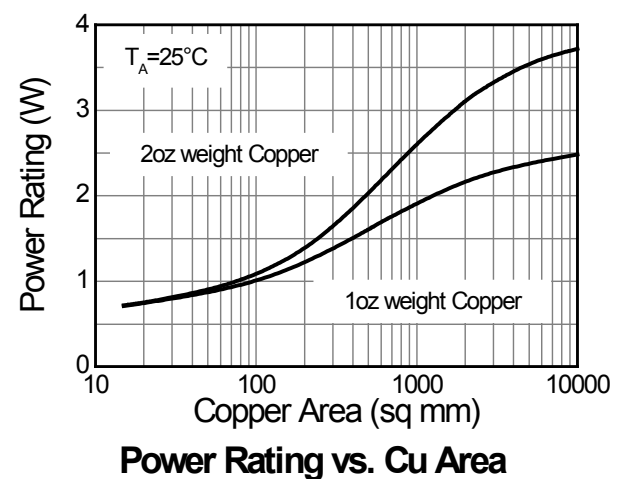
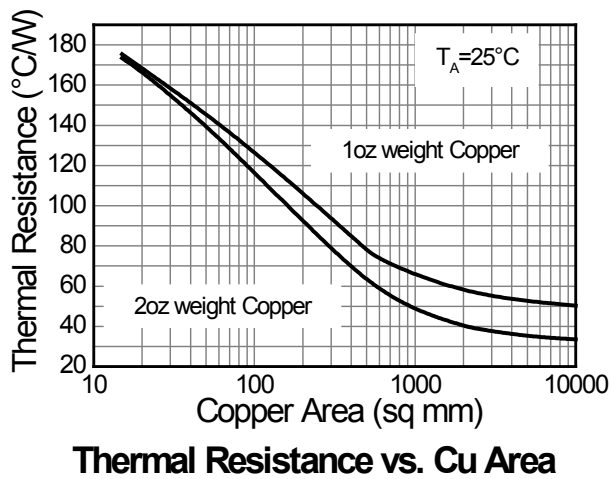
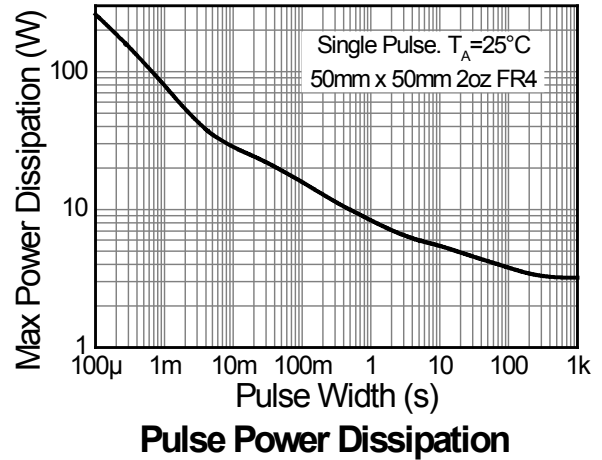
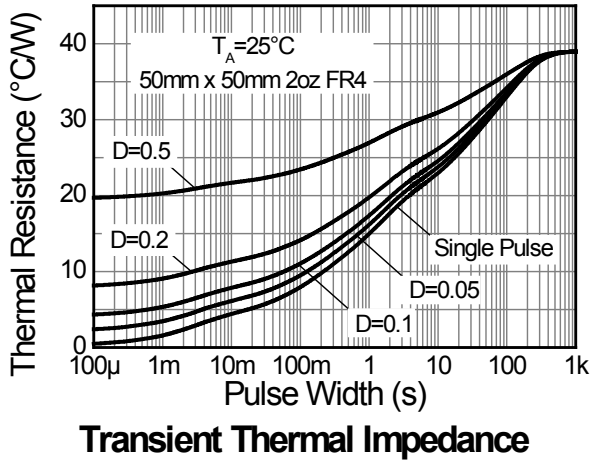
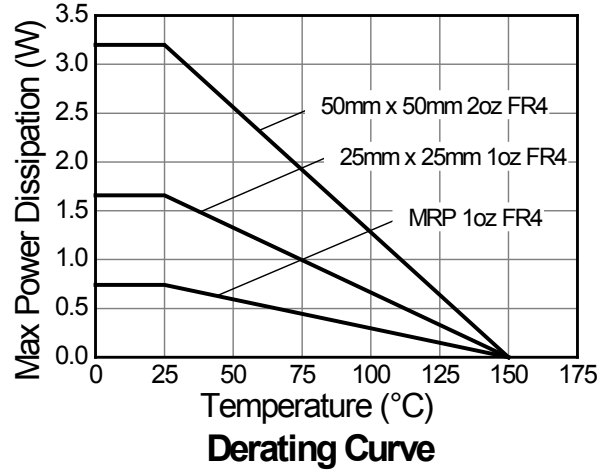
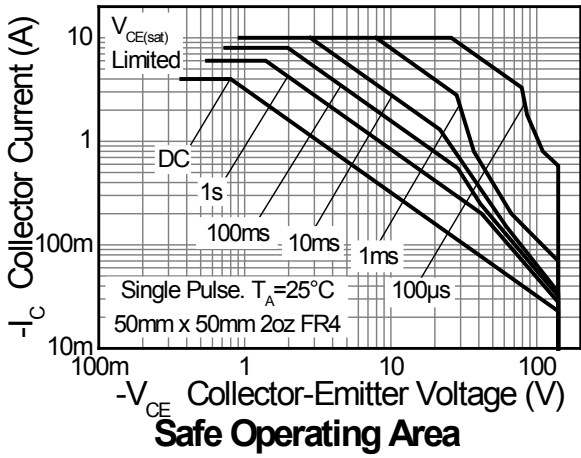
Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V <sub>CBO</sub>	-180	V
Collector-Emitter Voltage	V <sub>CEO</sub>	-140	V
Emitter-Base Voltage	V <sub>EBO</sub>	-7	V
Continuous Collector Current	I <sub>C</sub>	-4	A
Peak Pulse Current	I <sub>CM</sub>	-10	A

**Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Power Dissipation @ T <sub>A</sub> = 25°C (Note 5)	P <sub>D</sub>	3.2	W
Thermal Resistance, Junction to Ambient Air (Note 5) @T <sub>A</sub> = 25°C	R <sub>θJA</sub>	39	°C/W
Power Dissipation @ T <sub>A</sub> = 25°C (Note 6)	P <sub>D</sub>	1.7	W
Thermal Resistance, Junction to Ambient Air (Note 6) @T <sub>A</sub> = 25°C	R <sub>θJA</sub>	75	°C/W
Power Dissipation @ T <sub>A</sub> = 25°C (Note 7)	P <sub>D</sub>	0.74	W
Thermal Resistance, Junction to Ambient Air (Note 7) @T <sub>A</sub> = 25°C	R <sub>θJA</sub>	169	°C/W
Thermal Resistance, Junction to Collector Terminal	R <sub>θJT</sub>	5.6	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55 to +150	°C

- Notes:
5. Device mounted on FR-4 PCB, single sided 2 oz. copper, collector pad dimensions 50mm x 50mm.
  6. Device mounted on FR-4 PCB, single sided 1 oz. copper, collector pad dimensions 25mm x 25mm.
  7. Device mounted on FR-4 PCB, single sided 1 oz. copper, minimum recommended pad layout.

**Thermal Characteristics and Derating Information**

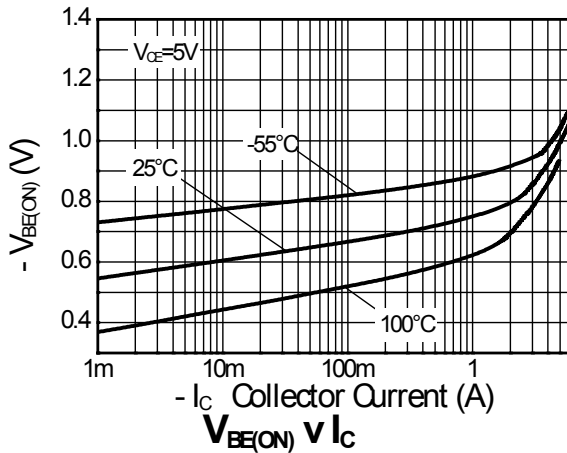
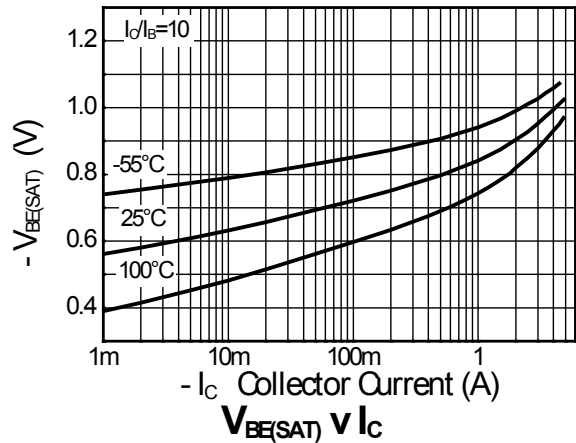
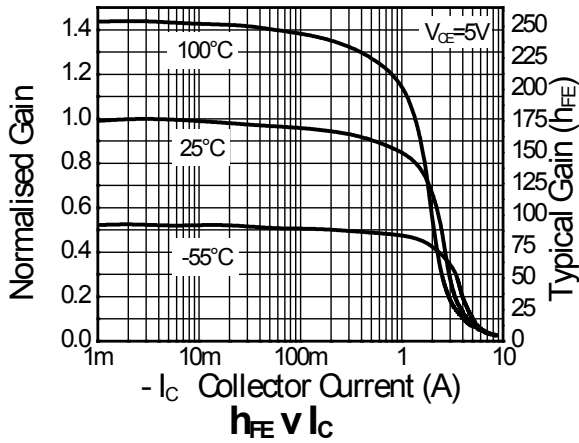
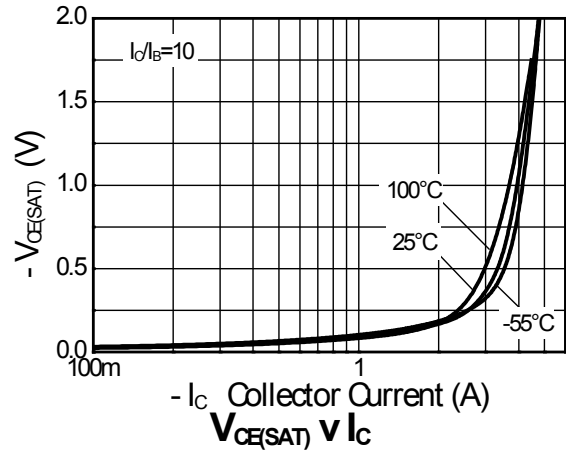
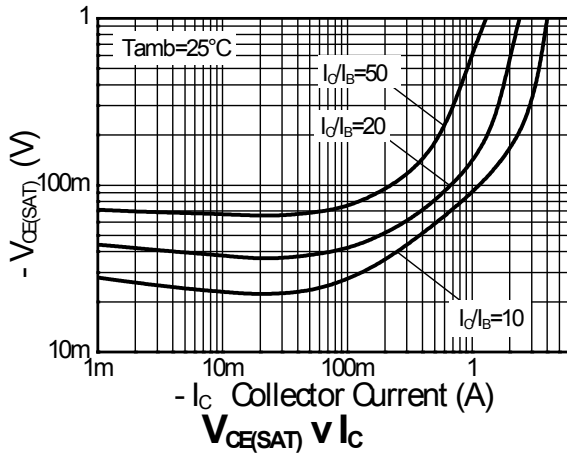


**Electrical Characteristics** @ $T_A = 25^\circ\text{C}$  unless otherwise specified

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Collector-Base Breakdown Voltage	$V_{(BR)CBO}$	-180	-200	—	V	$I_C = -100\mu\text{A}$
Collector-Emitter Breakdown Voltage (Note 8)	$V_{(BR)CEO}$	-140	-160	—	V	$I_C = -10\text{mA}$
Emitter-Base Breakdown Voltage	$V_{(BR)EBO}$	-7.0	-8.0	—	V	$I_E = -100\mu\text{A}$
Collector Cutoff Current	$I_{CBO}$	—	<1	-20 -0.5	nA $\mu\text{A}$	$V_{CB} = -150\text{V}$ $V_{CB} = -150\text{V}, T_{amb} = 100^\circ\text{C}$
Collector Cutoff Current	$I_{CER}$ $R \leq 1\text{k}\Omega$	—	<1	-20 -0.5	nA $\mu\text{A}$	$V_{CB} = -150\text{V}$ $V_{CB} = -150\text{V}, T_{amb} = 100^\circ\text{C}$
Emitter Cutoff Current	$I_{EBO}$	—	<1	-10	nA	$V_{EB} = -6\text{V}$
Collector-Emitter Saturation Voltage (Note 8)	$V_{CE(sat)}$	—	-40 -55 -85 -275	-60 -80 -120 -360	mV	$I_C = -0.1\text{A}, I_B = -5\text{mA}$ $I_C = -0.5\text{A}, I_B = -50\text{mA}$ $I_C = -1\text{A}, I_B = -100\text{mA}$ $I_C = -3\text{A}, I_B = -300\text{mA}$
Base-Emitter Saturation Voltage (Note 8)	$V_{BE(sat)}$	—	-940	-1040	mV	$I_C = -3\text{A}, I_B = -300\text{mA}$
Base-Emitter Turn-On Voltage (Note 8)	$V_{BE(on)}$	—	-830	-930	mV	$V_{CE} = -5\text{V}, I_C = -3\text{A}$
DC Current Gain (Note 8)	$h_{FE}$	100 100 45 —	225 200 100 5	— 300 — —	—	$V_{CE} = -5\text{V}, I_C = -10\text{mA}$ $V_{CE} = -5\text{V}, I_C = -1\text{A}$ $V_{CE} = -5\text{V}, I_C = -3\text{A}$ $V_{CE} = -5\text{V}, I_C = -10\text{A}$
Transition Frequency	$f_T$	—	120	—	MHz	$V_{CE} = -10\text{V}, I_C = -100\text{mA}$ , $f = 50\text{MHz}$
Output Capacitance	$C_{obo}$	—	33	—	pF	$V_{CB} = -10\text{V}, f = 1\text{MHz}$
Switching Times	$t_{on}$ $t_{off}$	— —	42 636	— —	ns ns	$V_{CC} = -50\text{V}, I_C = 1\text{A}$ , $I_{B1} = -I_{B2} = -100\text{mA}$

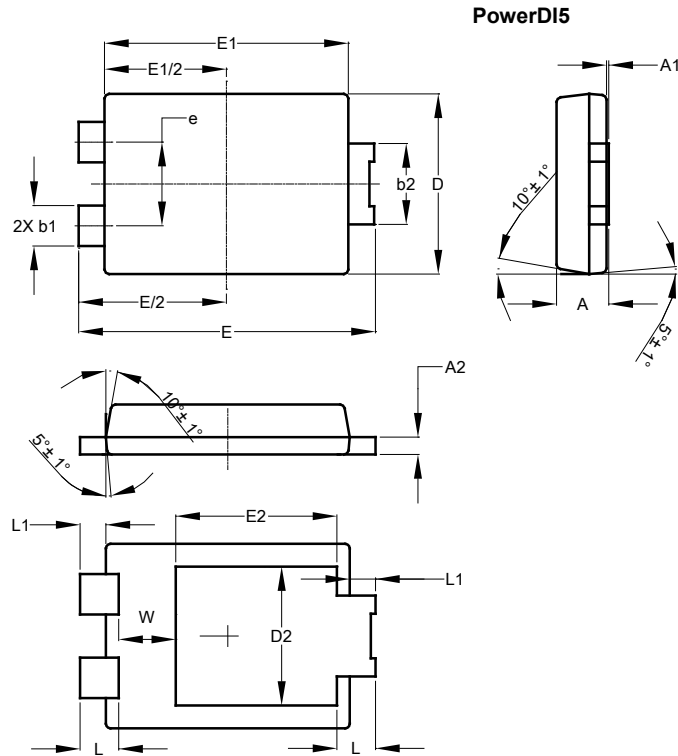
 Notes: 8. Pulse Test: Pulse width  $\leq 300\mu\text{s}$ . Duty cycle  $\leq 2.0\%$ .

**Typical Characteristic**



## Package Outline Dimensions

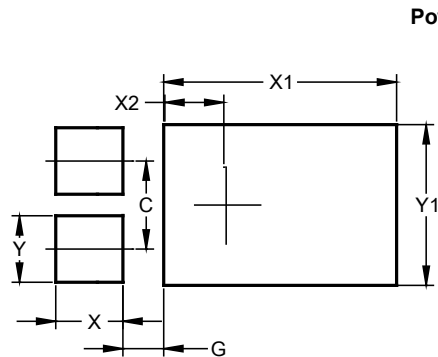
Please see <http://www.diodes.com/package-outlines.html> for the latest version.



PowerDI5			
Dim	Min	Max	Typ
A	1.05	1.15	1.10
A1	0.00	0.05	--
A2	0.33	0.43	0.381
b1	0.80	0.99	0.89
b2	1.70	1.88	1.78
D	3.90	4.05	3.966
D2	--	--	3.054
E	6.40	6.60	6.51
e	--	--	1.84
E1	5.30	5.45	5.37
E2	--	--	3.549
L	0.75	0.95	0.85
L1	0.50	0.65	0.57
W	1.10	1.41	1.255
All Dimensions in mm			

## Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.



Dimensions	Value (in mm)
C	1.840
G	0.852
X	1.400
X1	4.860
X2	1.310
Y	1.390
Y1	3.360

**IMPORTANT NOTICE**

DIODES INCORPORATED MAKES NO WARRANTY OF ANY KIND, EXPRESS OR IMPLIED, WITH REGARDS TO THIS DOCUMENT, INCLUDING, BUT NOT LIMITED TO, THE IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION).

Diodes Incorporated and its subsidiaries reserve the right to make modifications, enhancements, improvements, corrections or other changes without further notice to this document and any product described herein. Diodes Incorporated does not assume any liability arising out of the application or use of this document or any product described herein; neither does Diodes Incorporated convey any license under its patent or trademark rights, nor the rights of others. Any Customer or user of this document or products described herein in such applications shall assume all risks of such use and will agree to hold Diodes Incorporated and all the companies whose products are represented on Diodes Incorporated website, harmless against all damages.

Diodes Incorporated does not warrant or accept any liability whatsoever in respect of any products purchased through unauthorized sales channel. Should Customers purchase or use Diodes Incorporated products for any unintended or unauthorized application, Customers shall indemnify and hold Diodes Incorporated and its representatives harmless against all claims, damages, expenses, and attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized application.

Products described herein may be covered by one or more United States, international or foreign patents pending. Product names and markings noted herein may also be covered by one or more United States, international or foreign trademarks.

**LIFE SUPPORT**

Diodes Incorporated products are specifically not authorized for use as critical components in life support devices or systems without the express written approval of the Chief Executive Officer of Diodes Incorporated. As used herein:

A. Life support devices or systems are devices or systems which:

1. are intended to implant into the body, or
2. support or sustain life and whose failure to perform when properly used in accordance with instructions for use provided in the labeling can be reasonably expected to result in significant injury to the user.

B. A critical component is any component in a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or to affect its safety or effectiveness.

Customers represent that they have all necessary expertise in the safety and regulatory ramifications of their life support devices or systems, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of Diodes Incorporated products in such safety-critical, life support devices or systems, notwithstanding any devices- or systems-related information or support that may be provided by Diodes Incorporated. Further, Customers must fully indemnify Diodes Incorporated and its representatives against any damages arising out of the use of Diodes Incorporated products in such safety-critical, life support devices or systems.

Copyright © 2019, Diodes Incorporated

[www.diodes.com](http://www.diodes.com)